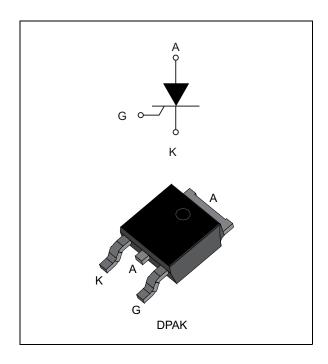




Standard 15 A SCRs

Datasheet - production data



Description

The TN1515-600B is a 15 A thyristor SCR housed in DPAK package. It fits any high voltage application that requires a high power density and compact housing design.

Table 1. Device summary

Symbol	Value	Unit
I _{T(RMS)}	15	А
V _{DRM} /V _{RRM}	600	V
I _{GT (Q₁)}	15	mA

Features

- On-state RMS current, I_{T(RMS)}: 15 A
- Repetitive peak off-state voltage, V_{DRM}/V_{RRM}: 600 V
- Triggering gate current, I_{GT}: 15 mA
- DPAK surface mount package

Application

- Universal motor DC phase control
- Power supply crowbar circuit
- Power Supply inrush limiter
- Motor soft start controller
- AC-DC voltage regulator

Benefits

- High AC surge current density
- Compact DPAK foot print

Characteristics TN1515-600B

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter			Value	Unit
I _{T(RMS)}	On-state RMS current (180° conduction angle)		T _c = 109 °C	15	Α
I _{T(AV)}	Average on-state current (180° cond	uction angle)	T _C = 109 °C	9.5	Α
1.	Non repetitive surge peak	$t_p = 8.3 \text{ ms}$	- T _j = 25 °C	165	А
ITSM	on-state current	t _p = 10 ms		150	
I ² t	I ² t value for fusing	t _p = 10 ms	T _j = 25 °C	113	A ² S
dl/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \le 100 \text{ ns}$	F = 120 Hz	T _j = 125 °C	50	A/µs
I _{GM}	Peak gate current $t_p = 20 \mu s$		T _j = 125 °C	4	Α
P _{G(AV)}	Average gate power dissipation $T_j = 125 ^{\circ}\text{C}$			1	W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range			- 40 to + 150 - 40 to + 125	°C
V _{RGM}	Maximum peak reverse gate voltage		5	V	

Table 3. Standard electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions		Values		Unit
ı	V - 12 V B - 22 O	T - 25 °C	MIN.	2	mΛ
I _{GT}	V_{out} = 12 V, R_L = 33 Ω	T _j = 25 °C	MAX.	15	mA
V _{GT}	V_{out} = 12 V, R_L = 33 Ω		MAX.	1.3	V
V _{GD}	$V_D = V_{DRM}, R_L = 3.3 \text{ k}\Omega$	T _j = 125 °C	MIN.	0.2	V
I _H	I _T = 500 mA		MAX.	40	mA
Ι _L	I _G = 1.2 I _{GT}		MAX.	60	mA
dV/dt	V _D = 67% V _{DRM,} gate open	T _j =125 °C	MIN.	200	V/µs
V_{TM}	$I_{TM} = 30 \text{ A}$ $t_p = 380 \mu\text{s}$	T _j = 25 °C	MAX.	1.6	V
V_{TO}	Threshold voltage	T _j = 125 °C	MAX.	0.85	V
R _D	Dynamic resistance	T _j = 125 °C	MAX.	25	mΩ
I _{DRM}	V- \(\sigma \)	T _j = 25 °C	MAX.	5	μA
I _{RRM}	$V_D/V_R = V_{DRM} = V_{RRM}$	T _j = 125 °C	IVIAA.	2	mA



TN1515-600B Characteristics

Table 4. Thermal resistance

Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case (DC)		1.2	°C/W
R _{th(j-a)}	Junction to ambient	$S^{(1)} = 0.5 \text{ cm}^2$	70	°C/W

^{1.} S = Copper surface under tab

Figure 1. Maximum average power dissipation versus average on-state current

P(W)

14

12

10

8

6

 \square_{α}

100

125

Figure 2. Average and DC on-state current versus case temperature

IT(AV) (A)

16

14

12

10

8

6

4

2

0

0

25

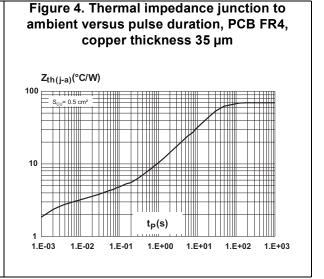
50

75

100

125

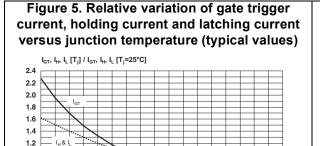
Figure 3. Average and DC on-state current versus ambient temperature, PCB FR4, copper thickness 35 μm



0.0

25

Characteristics TN1515-600B



1.0 0.8

0.6

0.4

0.2

1.E+02

0.01

Figure 6. Surge peak on-state current versus number of cycles ITSM (A) 180 160 140 Non repetitive T_i initial=25°C 120 100 80 60 40 Repetitive T_C=109°C 20 Number of cycles 0 1 10

Figure 7. Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10 ms

1.E+04

1.E+04

t_P(ms)

-40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90 100110120130

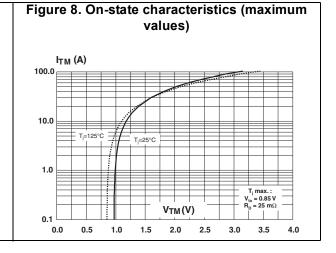
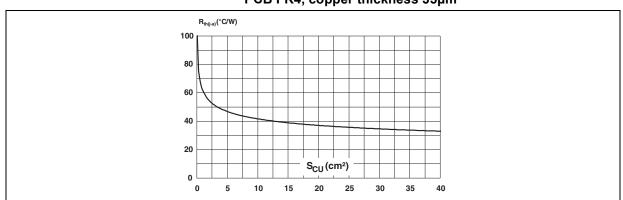


Figure 9. Junction to ambient thermal resistance versus copper surface under tab, PCB FR4, copper thickness 35µm



TN1515-600B Package information

2 **Package information**

- Epoxy meets UL94, V0
- Lead-free packages
- Halogen-free molding resin
- Recommended torque: 0.4 to 0.6 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 **DPAK** package information

D1 D Η <u>A1</u>

Figure 10. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

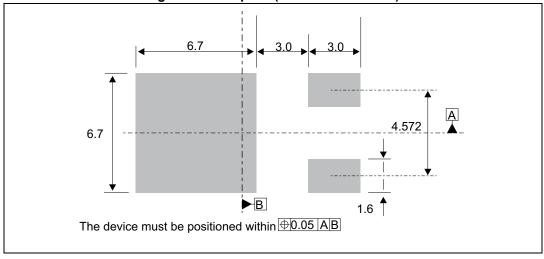


DocID12231 Rev 3 5/8 Package information TN1515-600B

Table 5. DPAK package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.18		2.40	0.086		0.0944
A1	0.9		1.10	0.035		0.0433
A2	0.03		0.23	0.0011		0.0090
b	0.64		0.90	0.0251		0.0354
b4	4.95		5.46	0.1948		0.2149
С	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0236
D	5.97		6.22	0.2350		0.2448
D1	4.95			0.1948		
Е	6.35		6.73	0.2500		0.2649
E1	4.32			0.1700		
е		2.286			0.09	
e1		4.572			0.18	
Н	9.35		10.40	0.3681		0.4094
L	1.0		1.78	0.039		0.0700
L2			1.27			0.0500
L4	0.6		1.02	0.023		0.0401
V2	-8°		+8°	-8°		+8°

Figure 11. Footprint (dimensions in mm)



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



TN1515-600B Ordering information

3 Ordering information

Figure 12. Ordering information schema

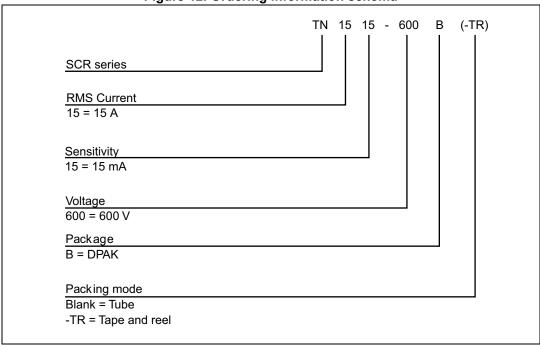


Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
TN1515-600B	TN15 15600	DPAK	0.3 g	75	Tube
TN1515-600B-TR	TN15 15600	DPAK	0.3 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
13-Mar-2006	1	Last update.
11-Jul-2007	2	TO-220AB delivery mode changed from bulk to tube.
21-Sep-2015	3	Updated <i>Features</i> , <i>Application</i> , <i>Description</i> and <i>Benefits</i> on cover page.Updated <i>Figure 7</i> , package information and reformatted to current standard.



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